



Click [here](#) for the 3D model.

Dimensions

Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
T	1.4mm +/-0.15mm
B	0.6mm +/-0.35mm

Packaging Specifications

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

General Information

Series	SMD Auto COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, High Voltage, Automotive Grade
Features	Ultra-Stable, Low Loss, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	62 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	360 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	20%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2400 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms